

# JNG25T60PS

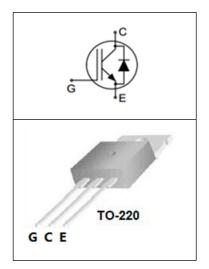
# IGBT

### Features

- 600V,25A
- V<sub>CE(sat)(typ.)</sub>=2.1V@V<sub>GE</sub>=15V,I<sub>C</sub>=25A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA

### **General Description**

JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as SMPS, general inverter and other switching applications.



# Absolute Maximum Ratings

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	600	V
Vges	Gate-Emitter Voltage	<u>+</u> 30	V
lc	Continuous Collector Current (Tc=25 °C)	45	A
IC	Continuous Collector Current (Tc=100°C)	25	A
Ісм	Pulsed Collector Current (Note 1)	75	А
lF	Diode Continuous Forward Current ( $T_c=100$ °C)	25	A
Ifm	Diode Maximum Forward Current (Note 1)	75	А
t <sub>sc</sub>	Short Circuit Withstand Time	10	us
D-	Maximum Power Dissipation (Tc=25 °C)	140	W
PD	Maximum Power Dissipation (Tc=100°C)	55	W
TJ	Operating Junction Temperature Range	-55 to +150	°C
Tstg	Storage Temperature Range	-55 to +150	°C

# **Thermal Characteristics**

Symbol	Parameter	Max.	Units	
R <sub>th j-c</sub>	Thermal Resistance, Junction to case for IGBT	0.9	°C/ W	
R <sub>th j-c</sub>	Thermal Resistance, Junction to case for Diode	1.2	°C/ W	
R <sub>th j-a</sub>	Thermal Resistance, Junction to Ambient	62	°C/ W	



### Electrical Characteristics (Tc=25°C unless otherwise noted )

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	$V_{GE}$ = 0V, I <sub>C</sub> = 250uA	600	-	-	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 600V, V <sub>GE</sub> = 0V	-	-	100	uA
	Gate Leakage Current, Forward	$V_{GE}$ =30V, $V_{CE}$ = 0V	-	-	100	nA
I <sub>GES</sub>	Gate Leakage Current, Reverse	$V_{GE}$ = -30V, $V_{CE}$ = 0V	-	-	100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 250 uA$	4.5	-	6.5	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 25A	-	2.1	2.6	V
Qg	Total Gate Charge	Vcc=400V	-	62		nC
Q <sub>ge</sub>	Gate-Emitter Charge	V <sub>CC</sub> =400V V <sub>GE</sub> =15V	-	8		nC
Q <sub>gc</sub>	Gate-Collector Charge	I <sub>C</sub> =25A	-	32		nC
t <sub>d(on)</sub>	Turn-on Delay Time		-	20	-	ns
t r	Turn-on Rise Time	Vcc=400V	-	27	-	ns
t d(off)	Turn-off Delay Time	V <sub>GE</sub> =15V	-	200	-	ns
t f	Turn-off Fall Time	Ic=25Α R <sub>G</sub> =28Ω	-	24	-	ns
Eon	Turn-on Switching Loss	Inductive Load	-	0.65	-	mJ
Eoff	Turn-off Switching Loss	Tc=25 ℃	-	0.28	-	mJ
Ets	Total Switching Loss		-	0.93	-	mJ
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> =25V	-	900	-	pF
Coes	Output Capacitance	V <sub>GE</sub> =0V	-	285	-	pF
Cres	Reverse Transfer Capacitance	f = 1MHz	-	70	-	pF

# Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> =25A	-	1.6	2.0	V
trr	Diode Reverse Recovery Time	V <sub>CE</sub> = 400V	-	85		ns
Irr	Diode peak Reverse Recovery Current	I <sub>F</sub> = 25A	-	14		А
Q <sub>r r</sub>	Diode Reverse Recovery Charge	dIF/dt = 200A/us	-	200		nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



#### **Typical Performance Characteristics**

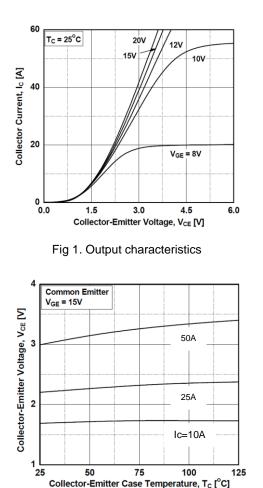


Figure 3. Saturation Voltage vs. Case Temperature at Variant Current Level

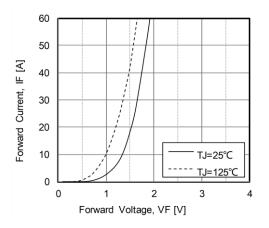
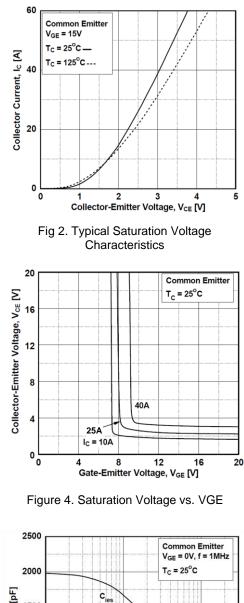


Figure 5. Forward Characteristics



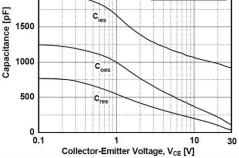
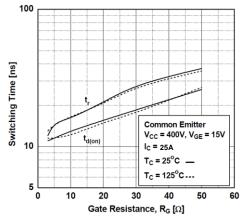
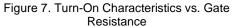


Figure 6. Capacitance Characteristics



#### **Typical Performance Characteristics**





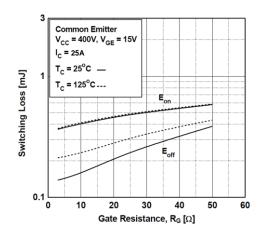
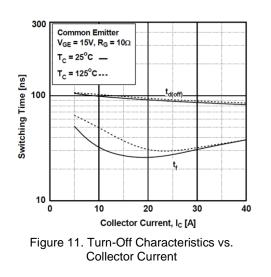
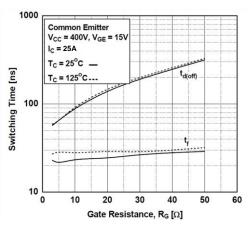
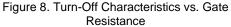


Figure 9. Switching Loss vs. Gate Resistance







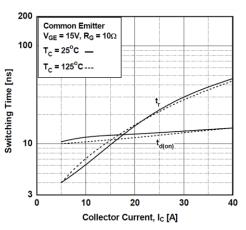
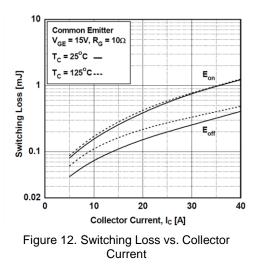


Figure 10. Turn-On Characteristics vs. Collector Current





#### **Typical Performance Characteristics**

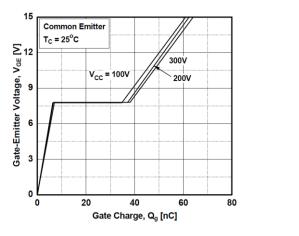
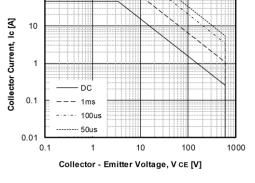
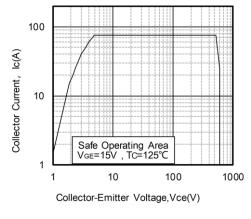


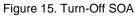
Figure 13. Gate Charge Characteristics



100

Figure 14. SOA Characteristics





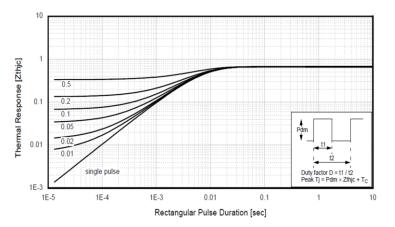
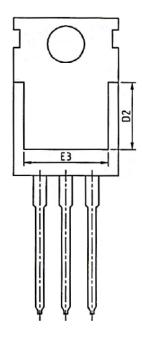


Figure 19. Transient Thermal Impedance of IGBT

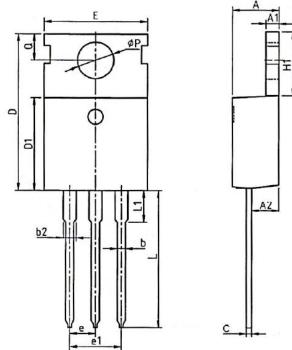


# JNG25T60PS

封装外型



SYMBOL	MIN	NOM	MAX	
Α	4.37	4.57	4.7	
A1	1.25	1.3	1.4	
A2	2.2	2.4	2.6	
b	0.7	0.8	0.95	
b2	1.17	1.27	1.47	
с	0.45	0.5	0.6	
D	15.1	15.6	16.1	
D1	8.8	9.1	9.4	
D2	5.5	-	-	
E	9.7	10	10.3	
E3	7	-	-	
е	2.54 BSC			
e1	5.08 BSC			
H1	6.25	6.5	6.85	
L	12.75	13.5	13.8	
L1	-	3.1	3.4	
ΦP	3.4	3.6	3.8	
Q	2.6	2.8	3	





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